Features

- Supply Voltage 5 V (Typically)
- Very Low Power Consumption: 150 mW (Typically) for -1 dBm Output Level
- Very Good Sideband Suppression by Means of Duty Cycle Regeneration of the LO
 Input Signal
- Phase Control Loop for Precise 90° Phase Shifting
- Power-down Mode
- Low LO Input Level: -10 dBm (Typically)
- 50- Ω Single-ended LO and RF Port
- LO Frequency from 100 MHz to 1 GHz
- SO16 Package01/03

Benefits

- No External Components Required for Phase Shifting
- Adjustment Free, Hence Saves Manufacturing Time
- Only Three External Components Necessary, this Results in Cost and Board Space Saving

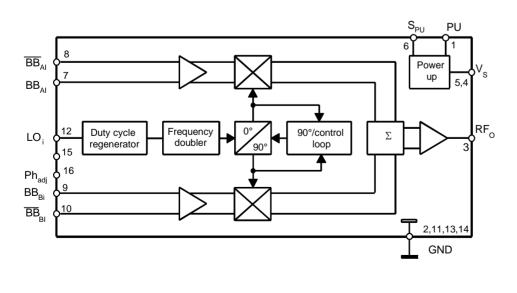
Electrostatic sensitive device. Observe precautions for handling.



Description

The U2790B is a 1000-MHz quadrature modulator using Atmel's advanced UHF process. It features a frequency range from 100 MHz up to 1000 MHz, low current consumption, and single-ended RF and LO ports. Adjustment-free application makes the direct converter suitable for all digital radio systems up to 1000 MHz, e.g., GSM, ADC, JDC.

Figure 1. Block Diagram





1000-MHz Quadrature Modulator

U2790B

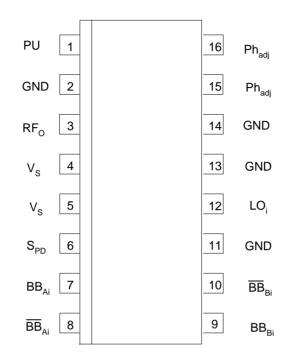
Rev. 4583A-CELL-01/03





Pin Configuration

Figure 2. Pinning SO16



Pin Description

Pin	Symbol	Function
1	PU	Power-up input
2, 11, 13, 14	GND	Ground
3	RF_{o}	RF output
4, 5	Vs	Supply voltage
6	S _{PU}	Settling time power-up
7	BB _{Ai}	Baseband input A
8	BB _{Ai}	Baseband input A inverse
9	BB _{Bi}	Baseband input B
10	BB _{Bi}	Baseband input B inverse
12	LO _i	LO input
15, 16	Ph _{adj}	Phase adjustment (not necessary for regular applications)

Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Supply voltage	Vs	6	V
Input voltage	V _i	0 to V _S	V
Junction temperature	Тj	125	°C
Storage temperature range	T _{Stg}	-40 to +125	°C

Operating Range

Parameters	Symbol	Value	Unit
Supply voltage range	Vs	4.5 to 5.5	V
Ambient temperature range	T _{amb}	-40 to +85	°C

Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient SO16	R _{thJA}	110	K/W

Electrical Characteristics

Test conditions (unless otherwise specified): $V_S = 5 V$, $T_{amb} = 25^{\circ}C$, referred to test circuit, system impedance $Z_O = 50 \Omega$, $f_{LO} = 900 \text{ MHz}$, $P_{LO} = -10 \text{ dBm}$, $V_{BBi} = 1 V_{pp}$ differential.

	-	BB: PP							
No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
1.1	Supply voltage range		4, 5	Vs	4.5		5.5	V	Α
1.2	Supply current		4, 5	ا _s	24	30	37	mA	А
2	Baseband Inputs								
2.1	Input-voltage range (differential)		7–8, 9–10	V _{BBi}		1000	1500	mV _{pp}	D
2.2	Input impedance (single ended)			Z _{BBi}		3.2		kΩ	D
2.3	Input-frequency range ⁽⁵⁾			f _{BBi}	0		250	MHz	D
2.4	Internal bias voltage			V _{BBb}	2.35	2.5	2.65	V	Α
2.5	Temperature coefficient			TC _{BB}		0.1	<1	mV/°C	D
3	LO Input								
3.1	Frequency range		12	f _{LOi}	50		1000	MHz	D
3.2	Input level (1)			P _{LOi}	- 12	- 10	- 5	dBm	D
3.3	Input impedance			Z _{iLO}		50		Ω	D

*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. The required LO level is a function of the LO frequency.

2. In reference to an RF output level \leq -1 dBm and I/Q input level of 400 mV $_{\rm pp}$ differential.

3. Sideband suppression is tested without connection at Pins 15 and 16. For higher requirements a potentiometer can be connected at these pins.

4. For T_{amb} = -30°C to +85°C and V_S = 4.5 to 5.5 V.

5. By low impedance signal source.





Electrical Characteristics (Continued)

Test conditions (unless otherwise specified): $V_S = 5 V$, $T_{amb} = 25^{\circ}C$, referred to test circuit, system impedance $Z_O = 50 \Omega$, $f_{LO} = 900 \text{ MHz}$, $P_{LO} = -10 \text{ dBm}$, $V_{BBi} = 1 V_{pp}$ differential.

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
3.4	Voltage standing wave ratio			VSWR _{LO}		1.4	2		D
3.5	Duty cycle range			DCR _{LO}	0.4		0.6		D
4	RF Output		1					1	
4.1	Output level		3	P _{RFo}	-5	-1	+2	dBm	В
4.2	LO suppression ⁽²⁾	f _{LO} = 900 MHz f _{LO} = 150 MHz		LO _{RFo}	30 32	35 35		dB	В
4.3	Sideband suppression ^(2, 3)	f _{LO} = 900 MHz f _{LO} = 150 MHz		SBS _{RFo}	35 30	40 35		dB	В
4.4	Phase error ⁽⁴⁾			Pe		<1		deg.	D
4.5	Amplitude error			A _e		< <u>+</u> 0.25		dB	D
4.6	Noise floor	$V_{BBi} = \frac{2}{V} V, \overline{V}_{BBi} = 3 V$ $V_{BBi} = \overline{V}_{BBi} = 2.5 V$		N _{FL}		-132 -144		dBm/Hz	D
4.7	VSWR			VSWR _{RF}		1.6	2		D
4.8	3rd-order baseband harmonic suppression			S _{BBH}	35	45		dB	D
4.9	RF harmonic suppression			S _{RFH}		35		dB	D
5	Power-up Mode	·							
5.1	Supply current	$\begin{array}{l} V_{PU} \leq 0.5 \text{ V}, \\ V_{PU} = 1 \text{ V} \end{array}$	4, 5	I _{PU}		10	1	μΑ	D
5.2	Settling time	$C_{SPU} = 100 \text{ pF},$ $C_{LO} = 100 \text{ pF}$ $C_{RFo} = 1 \text{ nF}$	6 to 3	t _{sPU}		10		μs	D
6	Switching Voltage								
6.1	Power-on		1	V _{PUon}	4			V	D
6.2	Power-up		1	V _{PUdown}			1	V	D

*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. The required LO level is a function of the LO frequency.

2. In reference to an RF output level \leq -1 dBm and I/Q input level of 400 mV $_{\rm pp}$ differential.

3. Sideband suppression is tested without connection at Pins 15 and 16. For higher requirements a potentiometer can be connected at these pins.

4. For T_{amb} = -30°C to +85°C and V_S = 4.5 to 5.5 V.

5. By low impedance signal source.

U2790B

Diagrams

Figure 3. Typical Single Sideband Output Spectrum at V_S = 4.5 V and V_S = 5.5 V, f_{LO} = 900 MHz, P_{LO} = -10 dBm, V_{BBI} = 1 V_{PP} (differential) T_{amb} = 25°C

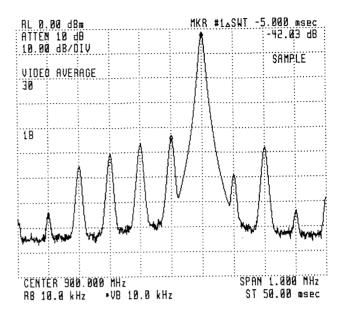


Figure 4. Typical GMSK Output Spectrum

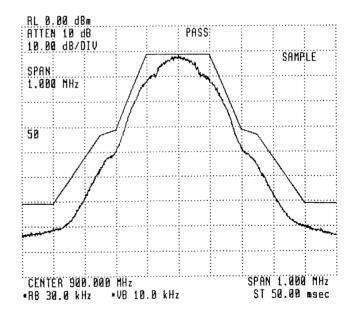






Figure 5. Demo Board Layout

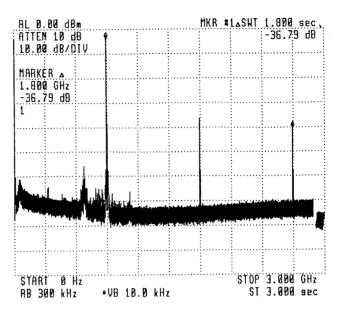
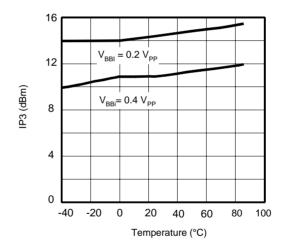
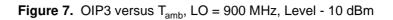


Figure 6. OIP3 versus T_{amb}, LO = 150 MHz, Level -20 dBm





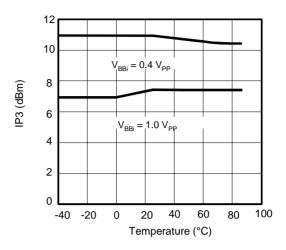


Figure 8. Output Power versus T_{amb}

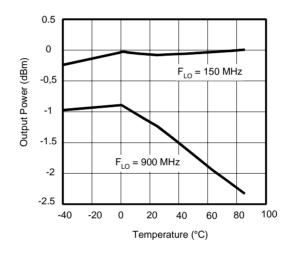
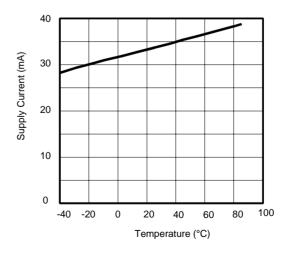


Figure 9. Supply Current versus T_{amb}







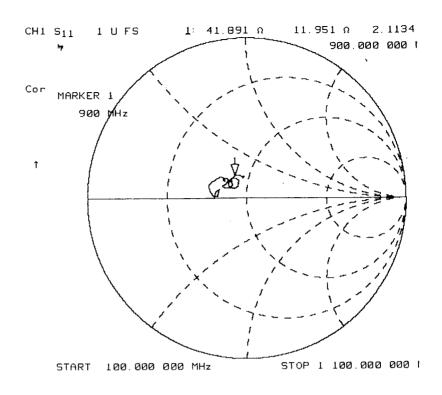
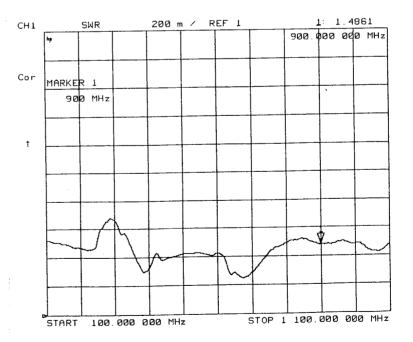


Figure 10. Typical S11 Frequency Response of the RF Output

Figure 11. Typical VSWR Frequency Response of the RF Output



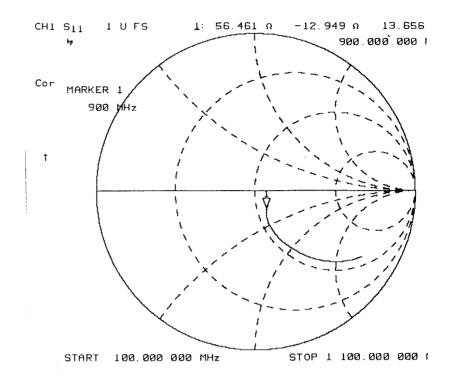


Figure 12. Typical S11 Frequency Response of the LO Input

Figure 13. Typical VSWR Frequency Response of the LO input

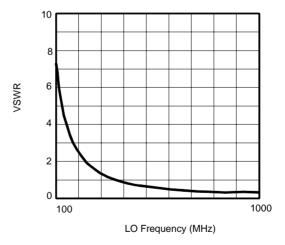






Figure 14. Typical Supply Current versus Temperature at $V_S = 5 V$

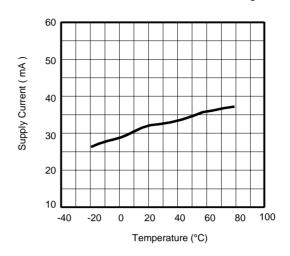


Figure 15. Typical Output Power versus LO-Frequency at $T_{amb} = 25^{\circ}C$, VBBI = 230 mV_{PP} (differential)

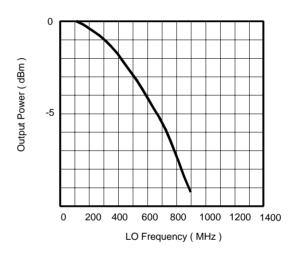
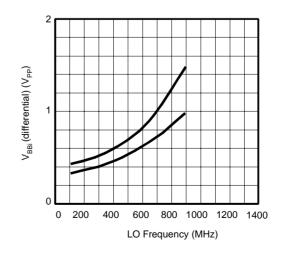


Figure 16. Typical required V_{BBi} Input Signal (differential) versus LO Frequency for PO = 0 dBm and P_O = - 2 dBm





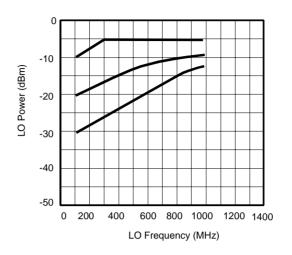


Figure 18. Application Circuit

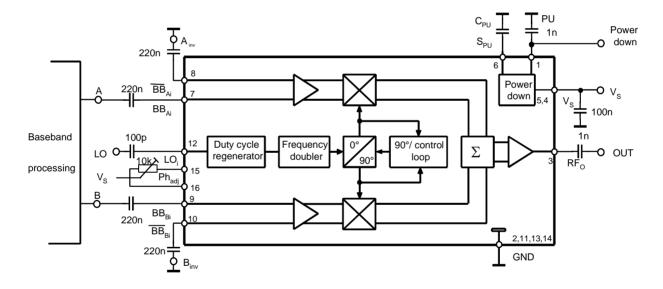
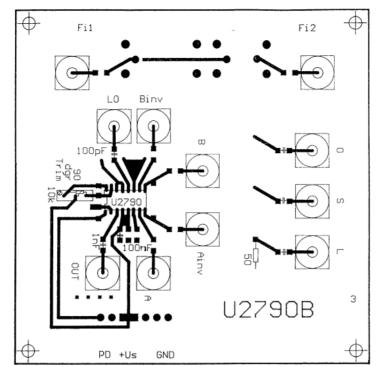






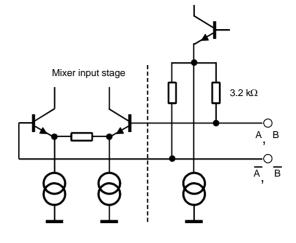
Figure 19. Demo Board Layout

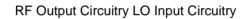


Application Notes

Noise Floor and Settling Time	In order to reduce noise on the power-up control input and improve the wide-off noise floor of the 900-MHz RF output signal, capacitor C_{PU} should be connected from Pin 6 to ground in the shortest possible way.
	The settling time has to be considered for the system under design. For GSM applications, a value of $C_{PU} = 1$ nF defines a settling time, t_{sPU} , equal or less than 3 ms. This capacitance does not have any influence on the noise floor within the relevant GSM mask. For mobile applications the mask requirements can be achieved very easily without C_{PU} .
	A significant improvement of the wide-off noise floor is obtainable with C_{PU} greater than 100 nF. Such values are recommended for applications where the settling time is not critical such as in base stations. Coupling capacitors for LO _i and RF _O also have a certain impact on the settling time. The values used for the measurements are CLO _i = 100 pF and C_{RFo} = 1 nF.
Baseband Coupling	The U2790B-FP (SO16) has an integrated biasing network which allows AC coupling of the baseband signal at a low count of external components. The bias voltage is 2.5 V \pm 0.15 V.
	Figure 19 shows the baseband input circuitry with a resistance of 3.2 k Ω for each asymmetric input. The internal DC offset between A and A, and B and B is typically < ± 1 mV with a maximum of ± 3 mV. DC coupling is also possible with an external DC voltage of 2.5 ± 0.15 V.

Figure 20. Baseband Input Circuitry





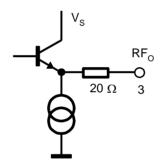
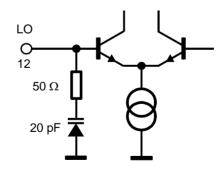


Figure 21. LO Input Circuitry



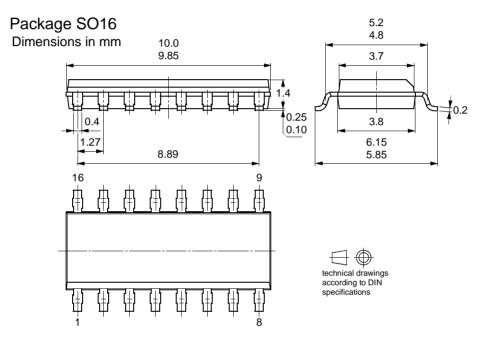




Ordering Information

Extended Type Number	Package	Remarks
U2790B-MFP	SO16	Tube
U2790B-MFPG3	SO16	Taped and reeled

Package Information



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